

# SODU1A THRU SODU1M Ultra-Fast Surface Mount Rectifiers

### **General description**

Ultra-fast Silicon Rectifier Reverse Voltage: 50 to 1000V

### Forward Current: 1.0A

### **FEATURES**

- The plastic package carries Underwriters Laboratory
- Flammability Classification 94V-0 Idea for printed circuit board
- · Glass passivated Junction chip Low reverse leakage
- · High forward surge current capability
- High temperature soldering guaranteed 250 C/10 seconds at terminals

### **MECHANICAL DATA**

- Case: Molded plastic body
- Terminals: Solder plated, solderable per MIL-STD-750,
  - Method 2026
- Polarity: Polarity symbol marking on body
- Mounting Position: Any
- Weight: 0.0007 ounce, 0.02 grams

# 0.157(4.00) 0.141(3.60) 0.192(2.60) 0.102(2.60) 0.102(2.60) 0.102(2.60) 0.102(2.60) 0.102(2.60) 0.102(2.60)

### Dimensions in inches and (millimeters)

### Absolute Maximum Ratings(Ta=25°C unless otherwise specified)

Parameter	SYMBOLS	SOD U1A	SOD U1B	SOD U1D	SOD U1G	SOD U1J	SOD U1K	SOD U1M	UNITS
Marking Code	Mark	U1A	U1B	U1D	U1G	U1J	U1K	U1M	N/A
Maximum repetitive peak reverse voltage	VRRM	50	100	200	400	600	800	1000	V
Maximum RMS voltage	VRMS	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	VDC	50	100	200	400	600	800	1000	V
Maximum average forward rectified current at T <sub>L</sub> =100 ℃	I <sub>(AV)</sub>	1.0							А
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	lfsm	35.0							А
Maximum instantaneous forward voltage at 1.0A	VF	1.0 1.4				1.7		V	
Maximum DC reverse current T A = 25 C at rated DC blocking voltage TA=125 C	lR	5.0 500						uA	
Max. reverse recovery-time (Note 1)	Trr	50 75					ns		
Typical junction capacitance (Note2)	C¹	9.0							pF
Typical thermal resistance	RqJA	85.0							°C/W
Operating junction and storage temperature range	ТЈ,Тѕтс	-55 to +150							°C

NOTES: 1. Reverse Recovery Test Conditions: IF=0.5A, IR=1.0A, Irr=0.25A

2. Measured at 1 MHz and applied Vr = 4.0 volts.



## **Ratings And Characteristic Curves**

FIG. 1- DERATING CURVE OUTPUT RECTIFIED CURRENT

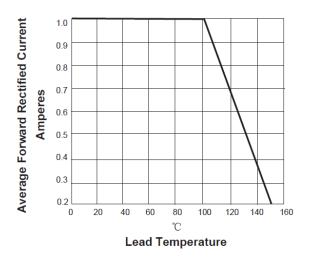


FIG. 3-TYPICAL FORWARD VOLTAGE CHARACTERISTICS

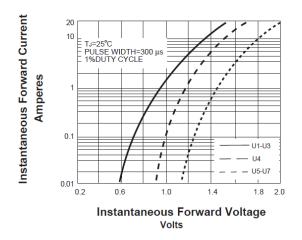


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT PERLEG

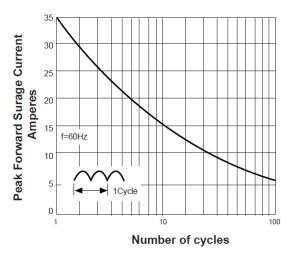
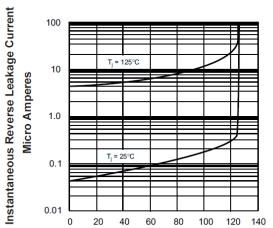


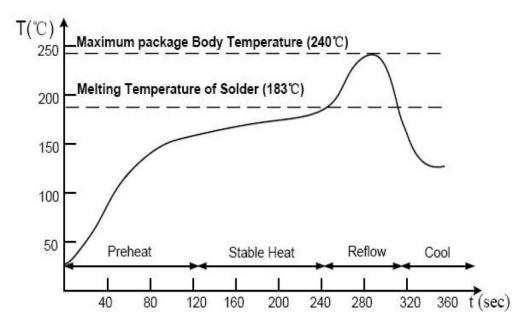
FIG. 4-TYPICAL REVERSE LEAKAGE CHARACTERISTICS



Percent Of Rated Peak Reverse Voltage(%)



# **Suggested Soldering Temperature Profile**



### Note

- Recommended reflow methods: IR, vapor phase oven, hot air oven, wave solder.
- → The device can be exposed to a maximum temperature of 265°C for 10 seconds.
- Devices can be cleaned using standard industry methods and solvents.
- → If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.



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